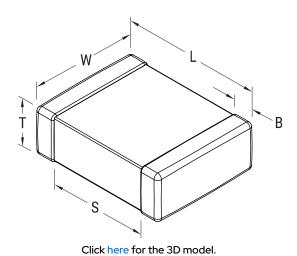


C1825C563KFRACTU

Specifications

Insulation Resistance

Aliases (C1825C563KFRAC7800) SMD Comm X7R HV, Ceramic, 0.056 uF, 10%, 1,500 VDC, X7R, SMD, MLCC, High Voltage, Temperature Stable, 1825, 2.3 mm



General Information	
Series	SMD Comm X7R HV
Style	SMD Chip
Description	SMD, MLCC, High Voltage, Temperature Stable
Features	High Voltage
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	310 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	1825
L	4.5mm +/-0.3mm
W	6.4mm +/-0.4mm
Т	2mm +/-0.20mm
S	2.3mm MIN
В	0.6mm +/-0.35mm

0.056 uF
1 kHz 1.0Vrms
10%
1500 VDC
1,800 VDC
-55/+125°C
X7R
15%, 1kHz 1.0Vrms
2.5% 1 kHz 1.0 Vrms
3% Loss/Decade Hour: Referee Time is 1000 Hours

17.8571 GOhms

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	500

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